

HD3SS215 Evaluation Module

This is the user's guide for the evaluation module (EVM) of the HD3SS215. The purpose of this user's guide is to facilitate an easy evaluation process for the HD3SS215 HDMI switch.

The contents of this user's guide are meant to provide an overview of the HD3SS215, which includes highlighting its key features, operating conditions, and how to setup this EVM for use in a system-level evaluation.

The construction of the HD3SS215 EVM also serves as a reference design that can be easily modified for any intended application. Target applications include notebooks, desktops, and docking stations. Schematics and layout information are included near the end.

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1 Introduction

The HD3SS215 is a high-speed passive switch capable of switching two full 4-lane ports from one of two sources to one target location in an application or from one source to one of two targets. The signal pass through the switch can be DisplayPort or HDMI/DVI signal. For DisplayPort applications, the HD3SS215 also supports switching of the auxiliary (AUX), display data channel (DDC), and hot plug detect (HPD) signals.

This EVM was designed to be used as a medium connection between one HDMI source and one of two HDMI sinks. The interface to the EVM consists of a standard HDMI connector to connect the EVM to your system setup with standard HDMI cables. Your test setup should look similar to Figure 1.

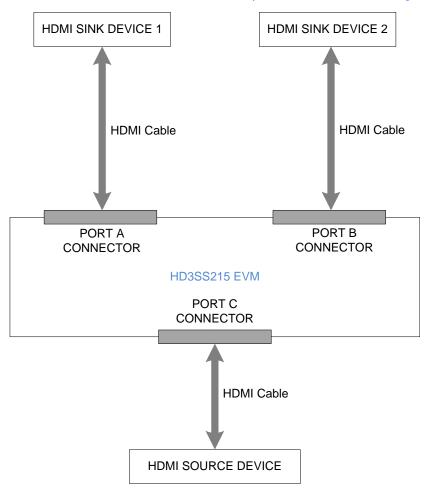


Figure 1. HD3SS215 EVM Simple System Block Diagram

2 HD3SS215 EVM Kit Contents

This EVM kit should contain the following items:

- HD3SS215 EVM board
- User's guide

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3 Description of EVM Board

The HD3SS215 EVM is designed to provide easy evaluation of the HD3SS215 device. It is also meant to serve as a reference design to show a practical example of how to use the device in a mass-production system. Table 1 highlights the EVM jumper functionality and configuration.

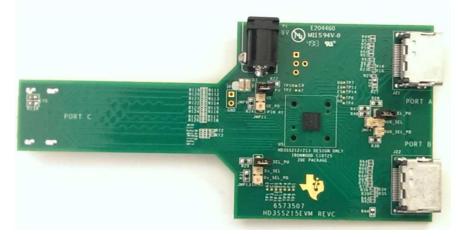


Figure 2. HD3SS215 EVM (Top Side)

Jumper	Description	Jumper Configuration
JMP10	VDD selection	No Connect for Nominal 3.3-V supply voltage Jumper pins 1 to 2 for 3.6-V supply voltage Jumper pins 2 to 3 for 3.0-V supply voltage
JMP11	HD3SS215 output enable	Jumper pins 1 to 2 to enable device outputs (default) Jumper pins 2 to 3 to disable device outputs
JMP4	HD3SS215 AUX SEL	Jumper pins 1 to 2 to enable Port B to C connection Jumper pins 2 to 3 to enable Port A to C connection
JMP13	HD3SS215 Dx SEL	Jumper pins 1 to 2 to enable Port B to C connection Jumper pins 2 to 3 to enable Port A to C connection

4 Power for the HD3SS215 EVM

The EVM should be powered with a +9-V DC power supply.

5 Monitoring the Device Current

To observe current consumption of the HD3SS215 in the device evaluation, the HD3SS215 EVM includes the option to monitor the current draw of the device. To enable this feature, take the following steps:

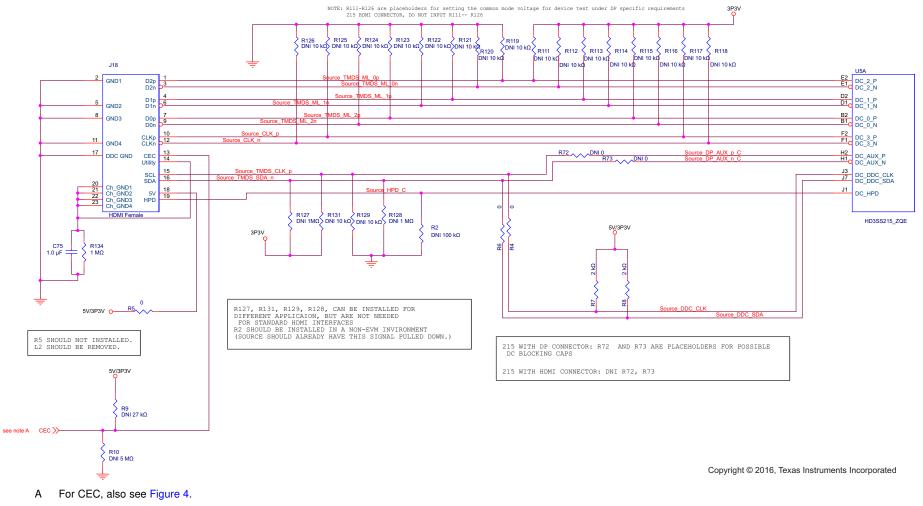
- 1. Uninstall the ferrite bead located at L2.
- 2. Obtain a power supply with the ability to display its current draw (or connect a current meter in series to the power supply) and connect to JMP9.
- 3. Turn on the power supply and observe the measured current on the power supply display (or current meter).

6 PCB Construction

This section discusses the construction of the EVM boards. It includes the board schematics and layout files to show how the board was built.

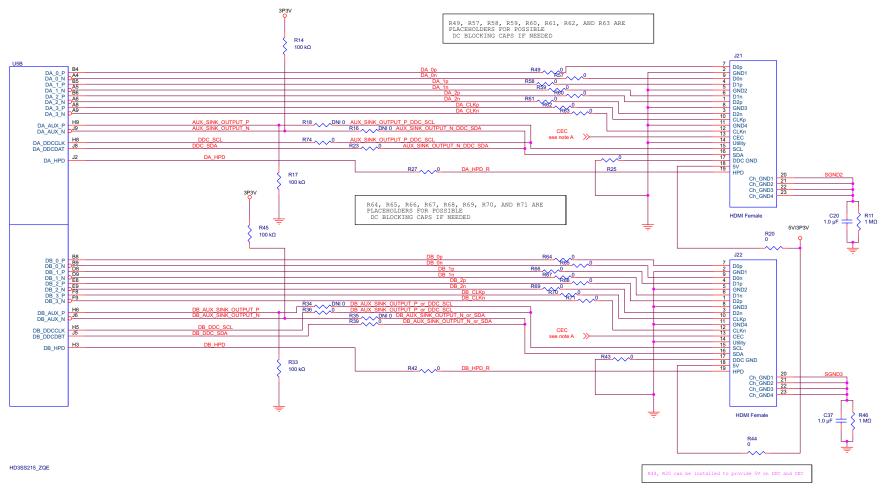
6.1 HD3SS215 EVM Board Schematics

This section shows the board schematics for the EVM.









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A For CEC, also see Figure 3.

B See Table 2.

Figure 4. HD3SS215 EVM Schematic Sink Ports A and B



Table 2. Section A BOM Changes

Reference Designator	DP Value	HDMI Value
C21	0.1 µF	0
C22	0.1 μF	0
C23	0.1 μF	0
C24	0.1 μF	0
C25	0.1 µF	0
C26	0.1 µF	0
C27	0.1 μF	0
C28	0.1 μF	0
R14	100 k	
R15	0	
R16	0	
R17	100 k	
R18	DNI	0
R19	DNI	0
R21	0	
R23	DNI	0
R25	0	
R26	DNI	0
R27	0	
R32	DNI	0
R13	1M	
J13	DP Rect	HDMI Rect
J14	DP Rect	HDMI Rect

Table 3. Switch Control Logic⁽¹⁾⁽²⁾

Control Lines	Switched I/O Pins			
Dx_SEL	DCz(p) Pin z = 0, 1, 2, or 3	DCz(n) Pin z = 0, 1, 2, or 3	HDPC Pin	CADC Pin (RSH)
L	DAz(p)	DAz(n)	HPDA	CADA
Н	DBz(p)	DBz(n)	HPDB	CADB

⁽¹⁾ OE pin – For normal operation, drive OE high. Driving the OE pin low will disable the switch.

⁽²⁾ Note: The ports which are not selected by the control lines will be in high impedance state.

Table 4. AUX/DDC Switch Control Logic

Control Lines		Switched I/O Pins			
AUX_SEL	Dx_SEL		AUXA	AUXB	AUXC
L	L	213 / 215	To or from AUXC	Z	To or from AUXA
L	Н	213 / 215	Z	To or from AUXC	To or from AUXB
Н	L	213 / 215	Z	Z	To or from DDCA
Н	Н	213 / 215	Z	Z	To or from DDCB
М	L	213	To or from DDCC	Z	Z

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А

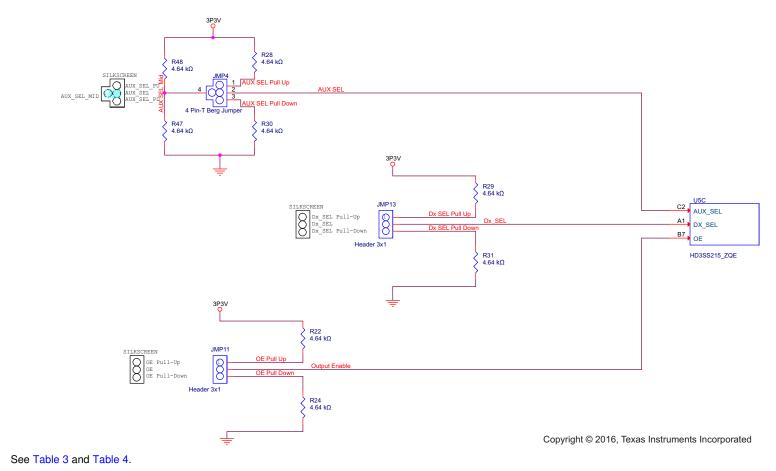
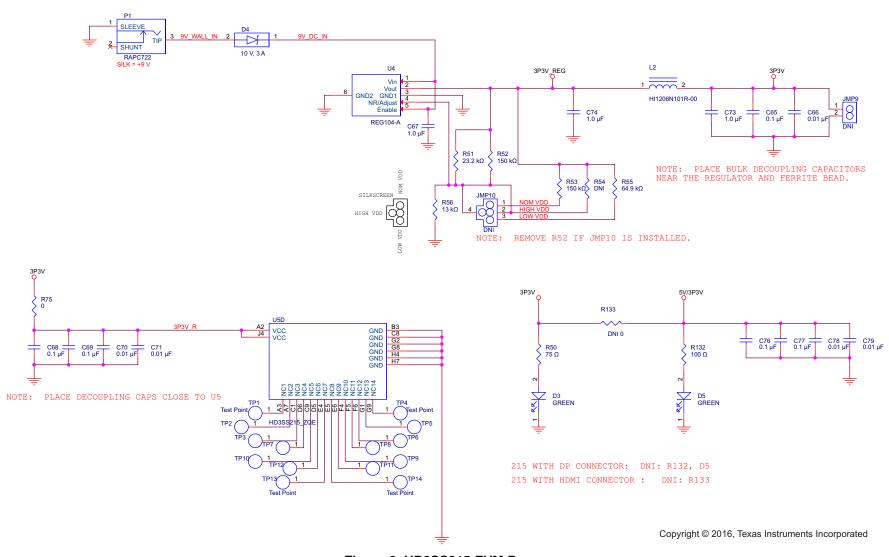


Figure 5. HD3SS215 EVM Control









6.2 HD3SS215 EVM Board Layout

This EVM was designed to show the implementation of this device on a 4-layer board.

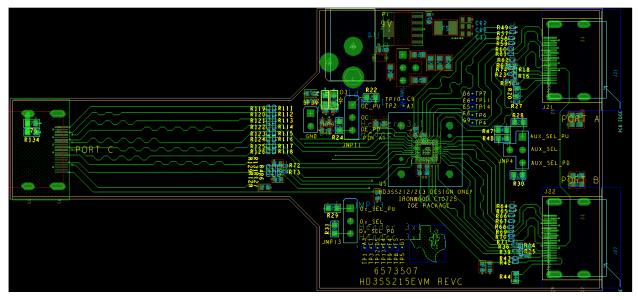


Figure 7. HD3SS215 EVM Layout Layer 1 (Top)

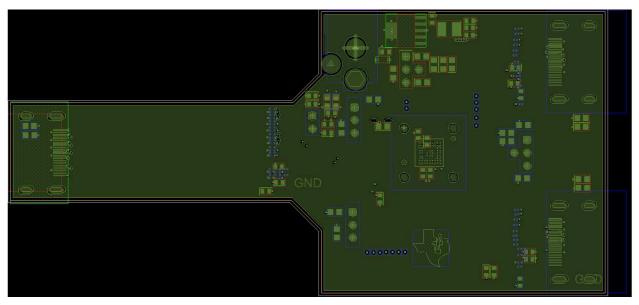


Figure 8. HD3SS215 EVM Layout Layer 2 (GND)

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HD3SS215 EVM Board Construction

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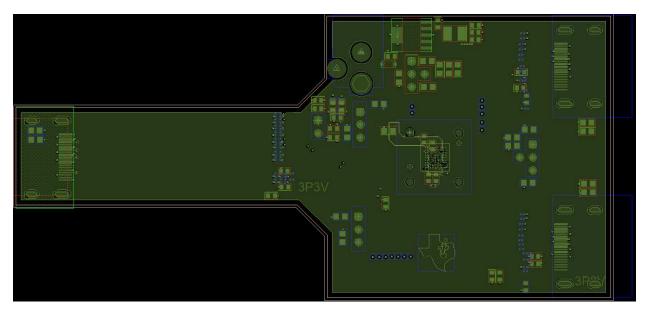


Figure 9. HD3SS215 EVM Layout Layer 3 (VCC)

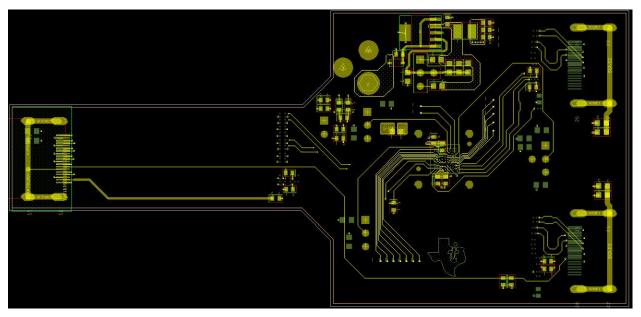


Figure 10. HD3SS215 EVM Layout Layer 4 (Bottom)

7 HD3SS215 EVM Board Construction

The HD3SS215 EVM board is a 4-layer board constructed of FR4 – TurboClad 370 material. The board stack-up consists of a signal layer on top, a ground layer, power layer, and a signal layer on bottom.

NOTE: To achieve the desired impedance, TI recommends that the user consult the board manufacturer for their process and design requirements.



8 HD3SS215 EVM Material Listing

Item	Quantity	Reference	Part
1	4	C20,C37,C67,C75	1.0uF
2	5	C65,C68,C69,C76,C77	0.1uF
3	5	C66,C70,C71,C78,C79	0.01uF
4	2	C73,C74	1.0 uF
5	2	D3,D5	GREEN
6	1	D4	10V, 3A
7	1	JMP4	4 Pin-T Berg Jumper
8	3	JMP9, JMP10, R54	DNI
9	2	JMP11, JMP13	Header 3x1
10	1	J18	HDMI Female C
11	1	J21	HDMI Female A
12	1	J22	HDMI Female B
13	1	L2	HI1206N101R-00
14	1	P1	RAPC722
15	1	R2	DNI 100k
16	30	R4, R5, R6, R20, R23, R25, R27, R36, R39, R42, R43, R44, R49, R57, R58, R59, R60, R61, R62, R63, R64, R65, R66, R67, R68, R69, R70, R71, R74, R75	0
17	2	R7, R8	2K
18	1	R9	DNI 27K
19	1	R10	DNI 5M
20	3	R11, R46, R134	1M
21	4	R14, R17, R33, R45	100K
22	7	R16, R18, R34, R35, R72, R73, R133	DNI 0
23	8	R22, R24, R28, R29, R30, R31, R47, R48	4.64K
24	1	R50	75
25	1	R51	23.2K
26	2	R52, R53	150K
27	1	R55	64.9K
28	1	R56	13K
29	18	R111, R112, R113, R114, R115, R116, R117, R118, R119, R120, R121, R122, R123, R124, R125, R126, R129, R131	DNI 10K
30	2	R127, R128	DNI 1M
31	1	R132	100
32	14	TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14	Test Point
33	1	U4	REG104-A
34	1	U5	HD3SS213/5_ZQE
35	1	U5	HD3SS213/5_ZQE

Table 5. EVM Bill of Materials



Page

Page

Revision History

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (April 2014) to A Revision

Changed Figure 3, terminal B2 To: DC_0_P, B1 To: DC_0_N and E2 To: DC_2_P, E1 To: DC_2_N
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Revision History

Changes from A Revision (April 2016) to B Revision	
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•	Deleted list item: "9-V DC power supply" from Section 2	2
•	Changed the sentence in Section 4	3

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CAUTION

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NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

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NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- · Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

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Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

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